USM Go A flexible Flaw Detector that can be a Thickness Gauge

Now with New Features The new ultrasonic Go platform from GE's Inspection Technologies business combines a thickness gauge and a flaw detector in one single lightweight instrument. With fast field software upgradeability, start with a USM Go and add DMS Go flaw detector capabilities as your inspections demand, or buy both initially.

The choice is yours!

See other side of the brochure for more information about the DMS Go.



USM Go

USM Go -Setting New Standards in Flaw Detection Instrumentation



Ergonomically Designed with the User in Mind

The USM Go ultrasonic portable flaw detector has been ergonomically designed to provide an instrument that is light, small and easy to use in the harshest of inspection environments.

Its ergonomic features include:

Portability

- Small size, lightweight, robust, dust- and waterproof construction allow the instrument to be easily operated in confined spaces, areas of difficult access, and in harsh environments.
- Can be operated with one hand, leaving other hand free for other tasks, such as maintaining probe in optimum position or holding on to ladders.
- Light enough to be carried throughout a whole day's shift.
- Battery provides up to 6 hours operation. Can be recharged on- or off-board.
- Several accessories to improve mobility are available: wrist strap, shoulder harness, belt holster.

Easy-to-Read Screen

- A display screen that is the same size as those in other GE flaw detectors, even though the instrument is much smaller than other instruments in the range.
- An 800 x 480 pixel display, which is better resolution than a standard DVD.
- A screen with an optimized aspect ratio to ensure highly defined echo separation.
- A screen that can be easily viewed. whether hand-held or desk-mounted.
- A screen that has been ergonomically sized to help reduce eyestrain.
- An integrated stand allows the user to optimize the viewing angle, when the instrument is desk- or benchmounted.
- AutoGate Threshold for faster measurement with optimum accuracy.
- NEW A-scan freeze mode function (for gate A and B) fascilitates working in difficult ergonomic conditions.
- **NEW** Display measurement indicators show both amplitude and distance to reduce risk of error.

Ease of Use

- Pressure-sensitive joystick imported and adapted from the successful range of remote visual inspection and ultrasonic equipment offered by GE.
- All controls within fingertip reach. User can dedicate function keys according to preference.
- A "Flip" function allows the instrument to be used equally well by left-handed and right-handed people.
- A standard USB connection to allow data to be downloaded from the flaw detector for further analysis or storage.
- The instrument's 2 GB memory can be easily exchanged by SD cards up to 16 GB.
- Reports are produced in jpeg format so there is no need for special reading software.
- NEW Printable summary list of all parameters.
- NEW Easy directory management on SD
- **NEW** Built-in menu customization tool allows to adapt the menu structure to two levels of users.
- Yearly calibration reminder for efficient quality management.
- Smart notes function increases reporting efficiency.





Increasing Productivity

The USM Go features intuitive operation so there is virtually no time-consuming, learning curve.

You are productive from the moment you pick it up!

There is no need to refer to the manual, as clear instructions are provided as you go along. Navigation is simplified using the proven graphical user interface (GUI) and the innovative joystick, allowing one-handed operation for fast and accurate adjustment.

Other features allowing increased productivity are:

- A robust molded rubber casing to withstand the harshest environments and significantly reduce downtime.
 The instrument is dust- and waterproof to IP67 and is tested to withstand shock and vibration.
- A simple on-board data logger to collect and save thickness measurements or eventually attach the corresponding A-scan image.
- Backwall Echo Attenuator (BEA) helps to find very small defects improving detectability.
- Automatic Gate Threshold for the 2 gates ensuring accurate measurements made under the same conditions.
- Video recording upto 8 minutes allows live reporting.

High UT Performance

- State-of-the-art electronics, including digital amplification, for a wide range of application benefits.
- A wide Pulse Repetition Frequency range allows use at low PRF to inspect forged parts without any "ghost" echoes and to inspect welds at high PRF when fast and regular scanning movement is required.
- Optional square wave pulser for more demanding applications.

Precise Time of Flight indication in µs.
TrueDGS compatible.

Versatile and Upgradeable

Customized versions of the USM Go are also available, specially adapted to meet specific inspection codes or applications. For example, an optional square wave pulser can be supplied for applications involving the inspection of highly attenuative material. The versions shown in the table are currently available. For more detailed information, please contact your local GE representative or visit www.ge-mcs.com.

All the (LEW) features of the USM Go are accessible to existing USM Go customers.

USM Go Options	USM Go Base	USM Go AWS	USM Go DAC AWS	USM Go Advanced
The Instrument	•	•	•	•
1 Battery	•	•	•	•
Battery Charger	•	•	•	•
Power Cable	•	•	•	•
Transportation Case	•	•	•	•
Brief Instruction Card	•	•	•	•
Operating Manual on CD	•	•	•	•
Manufacturer Certificate	•	•	•	•
Hand Strap	•	•	•	•
AWS	option	•	•	•
DAC / TCG	option	option	•	•
DGS	option	option	option	•
Phantom PRF	option	option	option	•
Square Wave Pulser	option	option	option	•
DMS Go Thickness Gauge Features	option	option	option	option
Backwall Echo Attenuator (BEA)	option	option	option	option

A Wide Range of Applications





The USM Go has been designed to provide flaw detection capability in inspection situations throughout the industrial and process spectrum, from aerospace to power generation and from the automotive sector to the oil and gas industry.

These include:

Weld Inspection:

- Trigonometric projections
- AWS
- DAC
- DGS

Inspection of Forgings and Castings:

- Manual PRF adjustment
- Phantom echo indicator
- DGS

Backwall Echo Attenuator (BEA)

Inspection of rails:

- High PRF (up to 2000 Hz)
- Lightweight: 850 g (1.87 lb)
- Small size and ergonomics

Inspection of Composites:

- RF Display
- 2 gates with B-start triggered with echo in gate A
- TCG correction with high slope 120 dB/µs
- Reflector depth indicated in layer

For more demanding applications:

- Narrow band filters
- Low noise digital amplifier
- Optional square wave pulser
- TCG correction with high slope 120 dB/µs

Backwall Echo Attenuator (BEA)

USM Go - Technical Specifications



LCD Display				
Active Area	W x H: 108 mm x 64.8 n	nm (4.25" x 2.55")		
Screen Diagonal	5.0"			
Pixel Resolution	W x H: 800 x 480 pixels			
Connectors				
Probe Connectors	Two LEMO-00			
UT Output Connector	SAP output, alarm			
USB Interface	Micro USB connector			
SD Card Connector	Full size SD card slot to accommodate standard SD cards			
Pulser - All pulser measu	urements taken according	to EN12668 specifications		
Pulser Mode	Simulated spike standard, uni-polar square wave optional			
Pulser Voltage (SQ Mode)	120 V to 300 V with 10 V steps			
Pulser Width (SQ Mode)	30 ns to 500 ns with 20 ns steps			
Pulser Amplitude (Spike Mode)	Low : 120 V High: 300 V			
Damping	50 or 1000 Ohms			
PRF	Automatically optimized between 15 Hz to 2000 Hz, 3 automatic adjustment modes : AutoLow, AutoMed, AutoHigh - Manual Control of PRF from 15 to 2000 Hz			
Receiver				
Range	14016 mm at steel longitudinal wave (557")			
Digital Gain	Dynamic range of 110 dB, with 0.2 dB step			
Analog Bandwidth	0.2 MHz - 20 MHz			
Filters	Broad band Narrow band filters	1; 2; 2.25; 4.5; 10; 13; 15 MHz		
Gate				
Independent Gates	2 Gates (A and B), Gate	2 Gates (A and B), Gate B can support triggering by Gate A		
Rectification	Full Wave (FW)	Positive (POS)		
	RF	Negative (NEG)		
Measurement	Peak	Flank		
	JFlank			
Measurement units	TOF Amplitude	in, mm, µs % dB		
Memory				
Capacity	2 GB SD card. Up to 16 GB memory cards can be used			
Report	Jpeg and BMP reports			
Data Logger	Option for thickness or A-scan recording, compatible with UltraMATE			

Environmental				
Battery	6 hours battery life			
	On board charging			
	Off board charging with optional adaptor			
	Proportional battery gauge indicating remaining operation time			
	Automatic energy server mode (Auto Off) allows saving battery life by putting the instrument in sleep mode automatically when not in use			
Charger	"Universal" AC (100-240	O V, 50-60 Hz)		
	Meets CCC, CE, UL, CSA and PSE requirements			
Size	175 mm x 111 mm x 50 mm (6.8" x 4.3" x 1.9")			
Weight	845 g (1.87 lb) with the battery			
Languages	Bulgarian, Chinese, Czech, Dutch, English, French, German, Hungarian, Italian, Japanese, Portuguese, Polish, Russian and Spanish			
Protection as per Mil-Sta	l-810F			
Damp Heat and Humidity (Storage)	10 cycles: 10 hrs at 60°C (140°F) down to 30°C (86°F), 10 hrs at 30°C (86°F) up to 60°C (140°F), transition within 2 hrs, 507.4			
Temperature Shock (Storage)	3 cycles: 4 hrs at -20°C (-4°F) up to 60°C (140°F), 4 hrs at 60°C (140°F), transitions within 5 minutes, 503.4 Procedure II			
Vibration	514.5-5 Procedure I, annex C, figure 6, general exposure: 1 hr each axis			
Shock	6 cycles each axis, 15 g, 11 ms half sine, 516.5 Procedure I			
Loose Cargo (In Shipping Container)	514.5 Procedure II			
Transit Drop (Packaged for Shipment)	516.5 Procedure IV, 26 drops			
Operating Temperature Range	0°C to 55°C (32 to 131°F)			
Storage Temperature Range	-20°C to 60°C (-4 to 140 °F) with battery, 24 hrs			
Dustproof / Waterproof	As per IEC 529 specification for IP67 classification			
Compliance	EMC/EMI	EN 55011		
		EN61000-6-2:2001		
	Ultrasound	EN 12668		
		ASTM E1324		
		E317		
		ANSI/NCSL Z 540-1-1994		
		MII STD 45662A		
		MIL STD 2154		
Options				
Backwall Echo Attenuator	Allows improved defect detectability			
USM Go AWS Option	AWS sizing tool accord code	ing to AWS D1.1 structural welding		
USM Go DAC Option	DAC sizing tool 16 points compliant with	EN 1712- EN 1713 - EN 1714		
		ASME & ASME III		
		JIS Z3060 compliant		
	TCG: 110 dB/µs slope			
USM Go DGS Option	DGS sizing tool compliant with EN 1712			
	NEW Including new true	cluding new trueDGS technology		
USM Go Embedded Data Logger Option	Custom linear and grid file creation			
USM Go Square Wave	Allows pulser parameters fine tuning			
Pulser Option	Voltage adjustment from 120 V to 300 V per 10 V steps			
	Pulse width adjustment	from 30 ns to 500 ns per 10 ns steps		
USM Go Phantom	Phantom PRF will help to identify ghost echo due to			
Indicator Option	multiple reflections in low materials			

USM Go

Upgrade your USM Go to the DMS Go Thickness Gauge

The USM Go uses the same operating and navigating platform as the DMS Go portable thickness gauge. By means of a simple software purchase your USM Go can benefit from all the DMS Go functionalities and perform advanced thickness measurements.

This means that NDT personnel now need to carry only one inspection instrument to perform accurate and dependable thickness measurement and flaw detection. A further benefit of this dual modality is a significant reduction in operator training times.



Build your own instrument!

An extensive range of upgrade possibilities is available. Choose any of the DMS Go options and add it to your USM Go package.

For more information contact your local GE representative or visit www.gesensinginspection.com